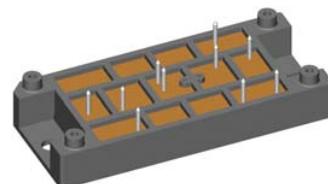
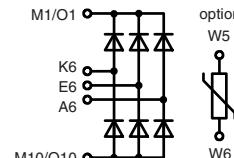


Three Phase Rectifier Bridge

$I_{dAVM} = 121 / 157 \text{ A}$
 $V_{RRM} = 1200-1600 \text{ V}$

V_{RRM}	Type	V_{RRM}	Type
V	V		
1200	VUO 120-12 NO1	1600	VUO 120-16 NO1
1200	VUO 155-12 NO1	1600	VUO 155-16 NO1



pin configuration see outlines

Symbol	Conditions	Maximum Ratings	
		VUO 120	VUO 155
V_{RRM}		1200/1600	1200/1600 V
I_{dAVM}	$T_c = 75^\circ\text{C}$, sinusoidal 120°	121	157 A
I_{FSM}	$T_{VJ} = 45^\circ\text{C}$, $T_{VJ} = 150^\circ\text{C}$, $t = 10 \text{ ms}, V_R = 0 \text{ V}$	650	850 A
	$t = 10 \text{ ms}, V_R = 0 \text{ V}$	580	760 A
I^{2t}	$T_{VJ} = 45^\circ\text{C}$, $T_{VJ} = 150^\circ\text{C}$, $t = 10 \text{ ms}, V_R = 0 \text{ V}$	2110	3610 A
	$t = 10 \text{ ms}, V_R = 0 \text{ V}$	1680	2880 A
P_{tot}	$T_c = 25^\circ\text{C}$ per diode	150	190 W
T_{VJ}		-40...+150	$^\circ\text{C}$
T_{VJM}		150	$^\circ\text{C}$
T_{stg}		-40...+125	$^\circ\text{C}$
V_{ISOL}	$50/60 \text{ Hz}$ $I_{ISOL} \leq 1 \text{ mA}$	$t = 1 \text{ min}$ $t = 1 \text{ s}$	3000 V~ 3600 V~
M_d	Mounting torque (M5) (10-32 unft)	2-2.5 18-22	Nm lb.in.
d_s	Creep distance on surface	12.7	mm
d_A	Strike distance in air	9.4	mm
a	Maximum allowable acceleration	50	m/s^2
Weight	typ.	80	g

Symbol	Conditions	Characteristic Values		
		($T_{VJ} = 25^\circ\text{C}$, unless otherwise specified)	min.	typ.
I_R	$V_R = V_{RRM}$, $V_R = V_{RRM}$,	$T_{VJ} = 25^\circ\text{C}$	0.3	mA
		$T_{VJ} = 150^\circ\text{C}$	5	mA
V_F	$I_F = 150 \text{ A}$,	$T_{VJ} = 25^\circ\text{C}$	VUO 120	1.59 V
			VUO 155	1.49 V
V_{FO}	For power-loss calculations only	VUO 120	0.80	V
		VUO 155	0.75	V
r_T	$T_{VJ} = 150^\circ\text{C}$	VUO 120	6.1	$\text{m}\Omega$
		VUO 155	4.6	$\text{m}\Omega$
R_{thJC}	per diode	VUO 120	1.0	K/W
		VUO 155	0.8	K/W
R_{thJH}		VUO 120	1.3	K/W
		VUO 155	1.1	K/W
R_{25} (option)	Siemens S 891/2,2/+9		2.2	$\text{k}\Omega$

IXYS reserves the right to change limits, test conditions and dimensions.

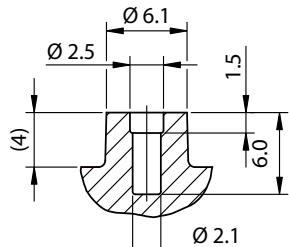
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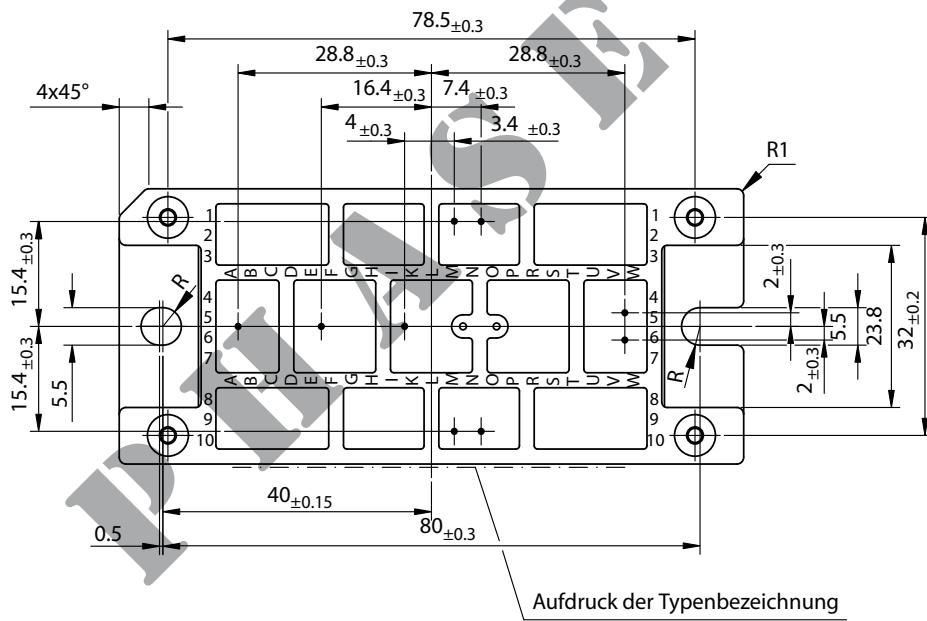
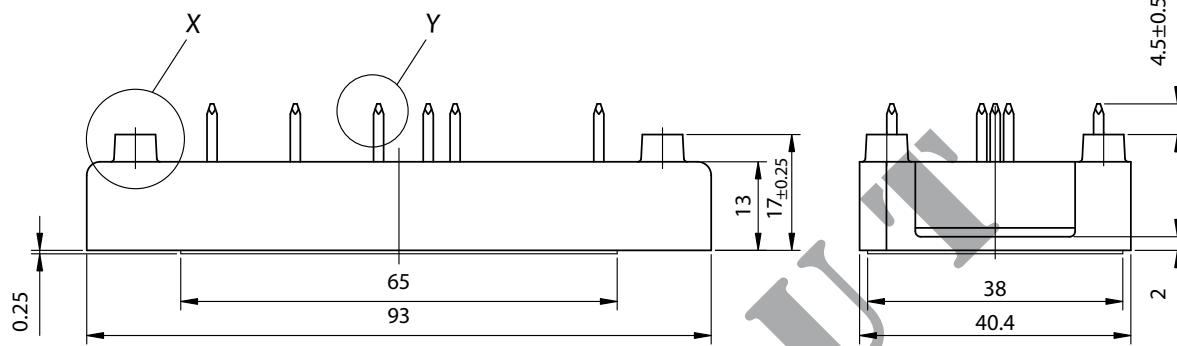
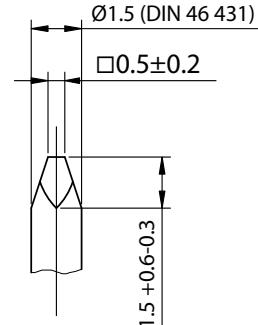
1 - 4

Dimensions in mm (1 mm = 0.0394")

Detail X M 2:1



Detail Y M 5:1



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2 - 4

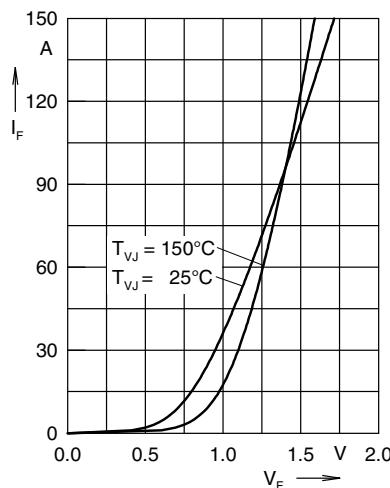


Fig. 1 Forward current versus voltage drop per diode

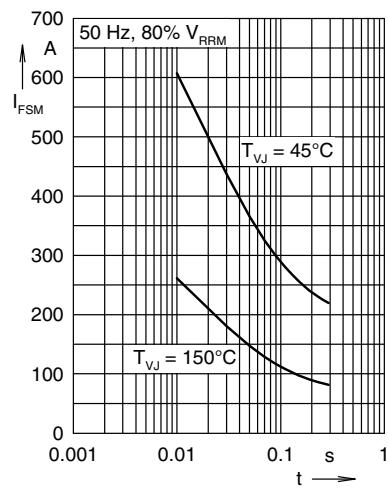


Fig. 2 Surge overload current

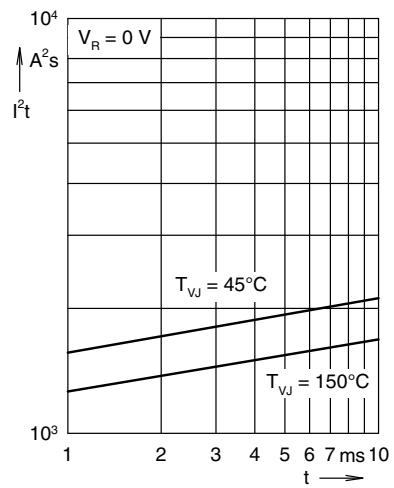
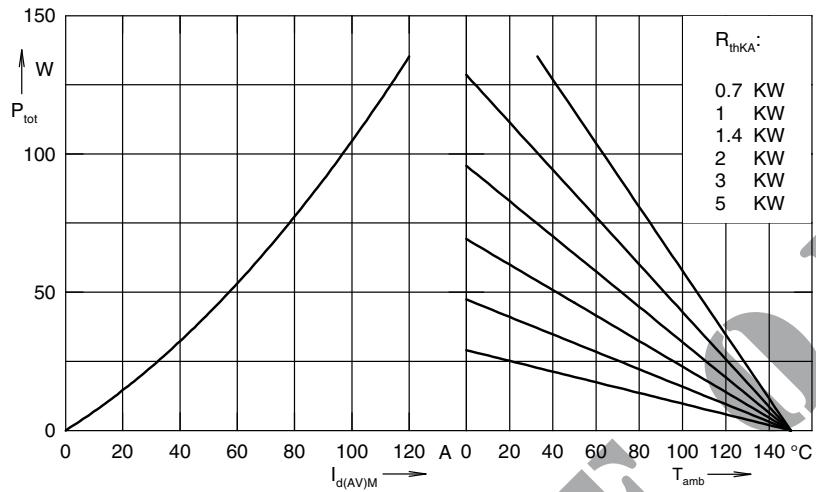
Fig. 3 I^2t versus time per diode

Fig. 4 Power dissipation versus direct output current and ambient temperature, sine 120°

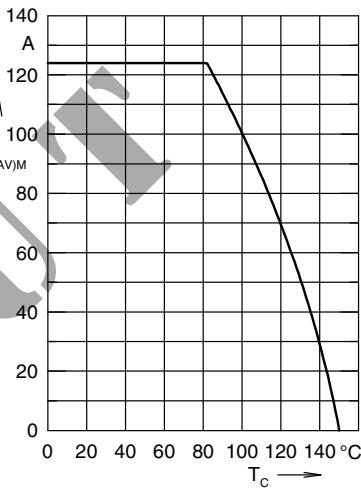


Fig. 5 Max. forward current versus case temperature

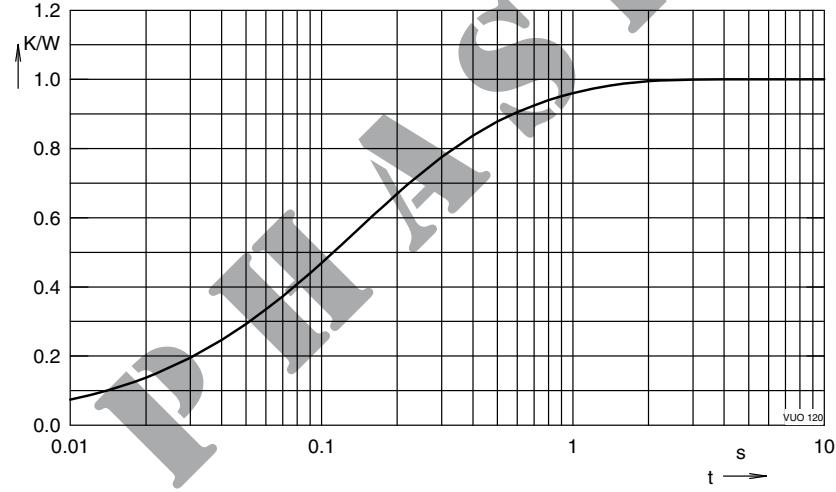


Fig. 6 Transient thermal impedance junction to case

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.003521	0.01
2	0.1479	0.05
3	0.5599	0.14
4	0.2887	0.5

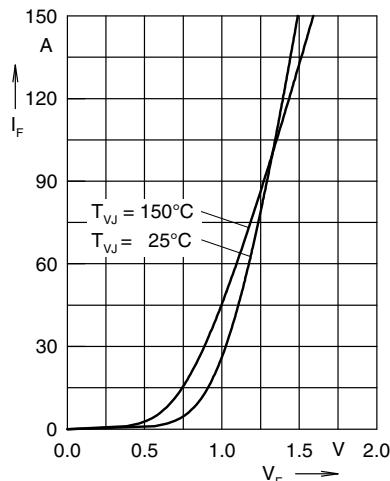


Fig. 1 Forward current versus voltage drop per diode

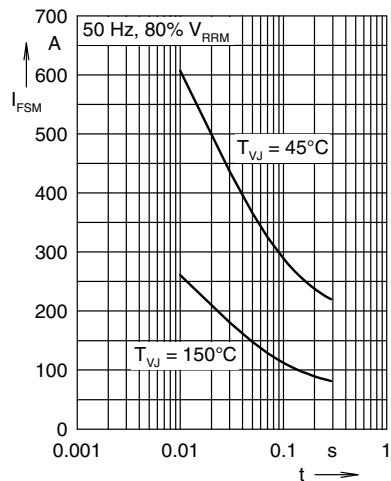


Fig. 2 Surge overload current

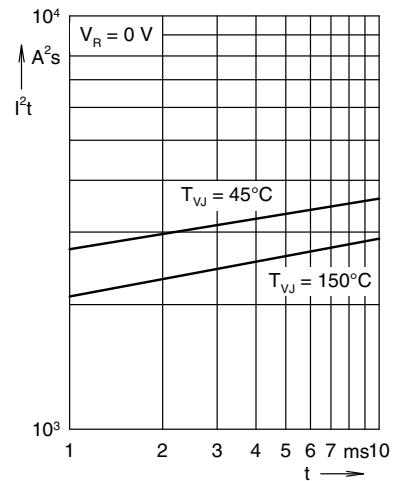


Fig. 3 I^2t versus time per diode

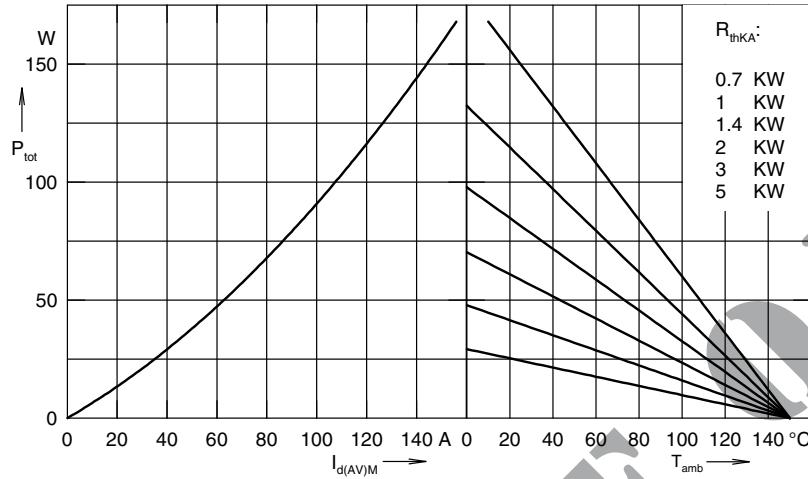


Fig. 4 Power dissipation versus direct output current and ambient temperature, sine 120°

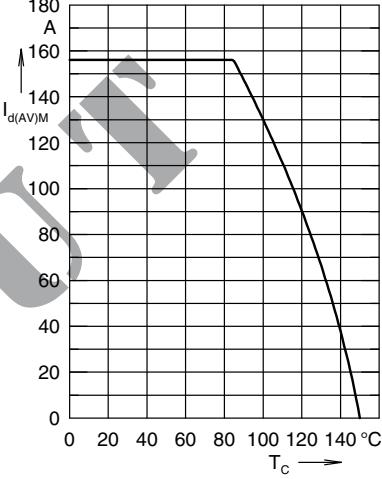


Fig. 5 Max. forward current versus case temperature

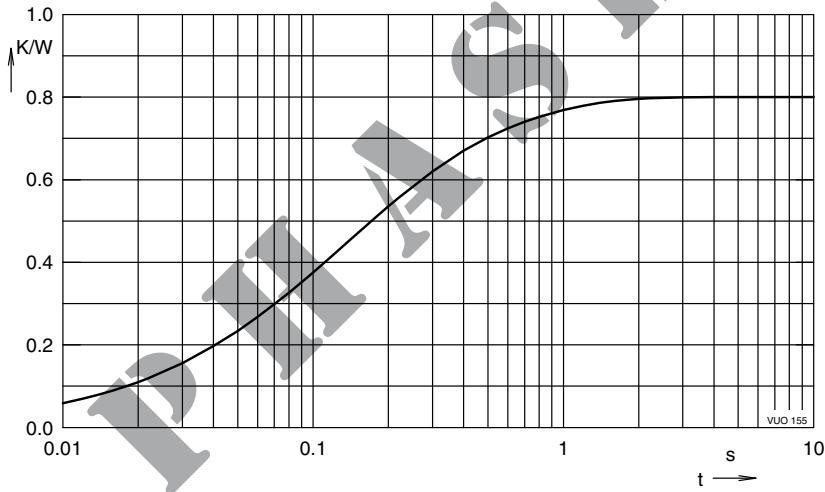


Fig. 6 Transient thermal impedance junction to case

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.002817	0.01
2	0.1183	0.05
3	0.4479	0.14
4	0.231	0.5